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Nishinomiya-shi (JP); **Murata**
Manufacturing Co., Ltd.,
Nagaokakyo-shi (JP)(51) **Int. Cl.**
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C08G 18/58 (2006.01)(72) Inventors: **Senichi OZASA**, Nishinomiya-shi (JP);
Tomomichi ICHIKAWA,
Nagaokakyo-shi (JP)(52) **U.S. Cl.**
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(57) **ABSTRACT**

A film capacitor that includes a dielectric resin film made of a thermosetting urethane resin; and a metal layer on at least one surface of the dielectric resin film, wherein the dielectric resin film contains at least an isocyanate group and a carbonyl group, and a ratio of a first absorption peak intensity of the isocyanate group in a wave number range of 2200 cm^{-1} to 2350 cm^{-1} to a second absorption peak intensity of the carbonyl group in a wave number range of 1650 cm^{-1} to 1800 cm^{-1} is 0.08 to 1.15.

